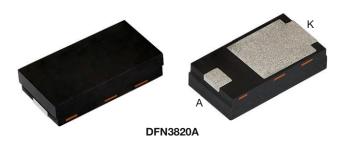


Vishay General Semiconductor

Surface-Mount TMBS[®] (Trench MOS Barrier Schottky) Rectifier



Anode O Cathode

LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS | | | | | |
|--|----------|--|--|--|--|
| I _{F(AV)} 7 A | | | | | |
| V _{RRM} | 100 V | | | | |
| I _{FSM} | 120 A | | | | |
| V _F at I _F = 3.5 A (T _J = 125 °C) | 0.45 V | | | | |
| T _J max. | 150 °C | | | | |
| Package | DFN3820A | | | | |
| Circuit configuration | Single | | | | |

FEATURES

- Low profile package typical height of 0.88 mm
- Leadless DFN package with side-wettable flanks suitable for customer AOI (Automatic Optical Inspection)
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 Automotive ordering code; base P/NHM3
- Compatible to SMP (DO-220AA) package case outline
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: DFN3820A

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test **Polarity:** color band denotes the cathode end

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted) | | | | | | |
|---|-----------------------------------|-------------|------|--|--|--|
| PARAMETER | SYMBOL | V7N103 | UNIT | | | |
| Device marking code | | V7G | | | | |
| Maximum repetitive peak reverse voltage | V _{RRM} | 100 | V | | | |
| Maximum average forward rectified current (fig. 1) | I _{F(AV)} ⁽¹⁾ | 7 | А | | | |
| Maximum average forward rectilied current (lig. 1) | I _{F(AV)} ⁽²⁾ | 2.2 | A | | | |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I _{FSM} | 120 | А | | | |
| Operating junction temperature range | T _J ⁽³⁾ | -40 to +150 | °C | | | |
| Storage temperature range | T _{STG} | -55 to +150 | °C | | | |

Notes

⁽¹⁾ With infinite heatsink

(2) Free air, mounted on FR4 PCB, 2 oz., standard footprint

 $^{(3)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: dP_D/dT_J < 1/R_{θ JA}

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RoHS

COMPLIANT HALOGEN

FREE



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| ELECTRICAL CHARACTERISTICS ($T_J = 25 \text{ °C}$ unless otherwise noted) | | | | | | |
|---|------------------------|---|-------------------------------|-------|------|------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| | l _F = 3.5 A | T _J = 25 °C | V _F ⁽¹⁾ | 0.51 | - | V |
| Instantaneous forward voltage | $I_F = 7 A$ | | | 0.61 | 0.66 | |
| Instantaneous forward voltage | l _F = 3.5 A | T _J = 125 °C | | 0.45 | - | |
| | I _F = 7 A | | | 0.56 | 0.60 | |
| | V _R = 70 V | T _J = 25 °C T _J = 125 °C | I _R ⁽²⁾ | 0.006 | - | mA |
| Reverse current | | T _J = 125 °C | | 3.5 | - | |
| Reverse current | V _R = 100 V | T _J = 25 °C T _J = 125 °C | | - | 0.33 | |
| | | T _J = 125 °C | | 9 | 25 | |
| Typical junction capacitance | 4.0 V, 1 MHz | | CJ | 860 | - | pF |

Notes

⁽¹⁾ Pulse test: 300 µs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: pulse width \leq 5 ms

| THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise specified) | | | | | | |
|--|---------------------------------|------|------|------|--|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | | |
| Thermal resistance | R _{0JA} (1)(2) | 135 | 169 | °C/W | | |
| | R _{0JM} ⁽³⁾ | 5 | 6.3 | 0/10 | | |

Notes

⁽¹⁾ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint

⁽³⁾ Thermal resistance junction-to-mount to follow JEDEC 51-14 transient dual interface test method (TDIM)

ORDERING INFORMATION TABLE

Device code

| v | 7 | Ν | 10 | 3 | Н | М3 |
|---|---|---|----|---|---|----|
| 1 | 2 | 3 | 4 | 5 | 6 | 7 |

1 - Vishay TMBS product

4

5

6

7

- 2 Current rating (7 = 7 A)
- **3** Package type (N = DFN3820A)
 - Voltage rating (10 = 100 V)
 - TMBS generation option (3 = Gen3)
 - Quality grade (H = AEC-Q101 qualified, otherwise = industry grade)
 - Material / Environment category (M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free)

| ORDERING INFORMATION (Example) | | | | | | | |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|--|--|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | | | |
| V7N103-M3/H | 0.023 | Н | 3500 | 7" diameter plastic tape and reel | | | |
| V7N103-M3/I | 0.023 | I | 14 000 | 13" diameter plastic tape and reel | | | |
| V7N103HM3/H ⁽¹⁾ | 0.023 | Н | 3500 | 7" diameter plastic tape and reel | | | |
| V7N103HM3/I ⁽¹⁾ | 0.023 | I | 14 000 | 13" diameter plastic tape and reel | | | |

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

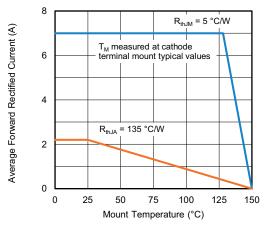


Fig. 1 - Maximum Forward Current Derating Curve

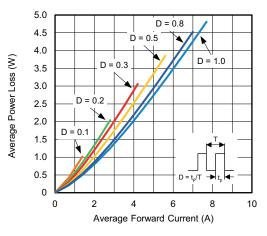


Fig. 2 - Forward Power Loss Characteristics

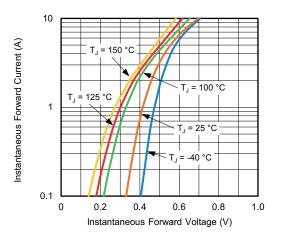


Fig. 3 - Typical Instantaneous Forward Characteristics

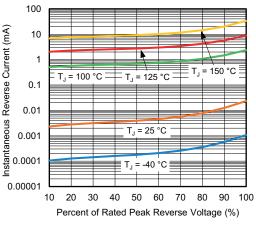


Fig. 4 - Typical Reverse Characteristics

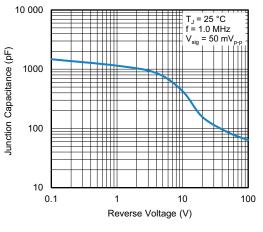


Fig. 5 - Typical Junction Capacitance

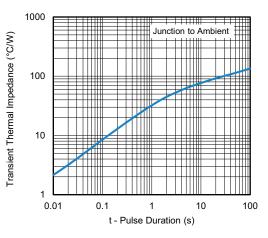


Fig. 6 - Typical Transient Thermal Impedance

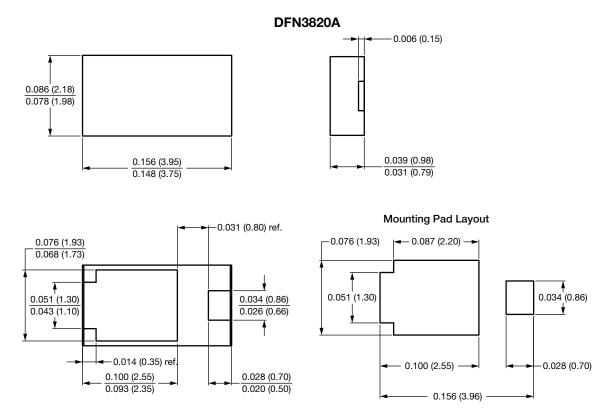
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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